

RZ/T1 Group

EtherCAT Sample Program Implementation Guide for Devices with a Built-in R-IN Engine Not Utilizing the HW-RTOS

R01AN3173EJ0110 Rev.1.10 Aug 31, 2018

Outline

This application note describes the sample programs for enabling RZ/T1 group devices that are equipped with a built-in R-IN engine to serve as EtherCAT® slaves that are used to control industrial AC servo motors or other devices with EtherCAT communication via PLC.

The features of the sample programs are as follows:

- The sample programs run with the Cortex-R4 and Cortex-M3 cores. The Cortex-M3 core handles EtherCAT communication, and the Cortex-R4 core handles generation of data to be sent to the EtherCAT master and display of received data with LEDs. A shared memory driver is used for communication between the CPUs.
- An EtherCAT communication program is created by using the Beckhoff SSC Tool (EtherCAT slave sample code generation tool). The SSC Tool project file and ESI file, and patch file that corrects the sample program coding (such as the sections that depend on the RZ/T1 hardware) are provided.
- The following two sample programs are provided:
 - (1) Simple I/O controller sample program for 32-bit I/O processing (hereafter, I/O controller sample program)
 - (2) Sample program for verifying the CiA402 drive profile (hereafter, CiA402 sample program)
- In these sample programs, the Cortex-M3 core does not utilize the HW-RTOS.

Target Device

RZ/T1 group devices with a built-in R-IN engine.

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1. Specifications

Table 1.1 lists the peripheral modules to be used and applications. Figure 1.1 shows the operating environment.

Table 1.1 Peripheral Modules and Applications

| Peripheral Module | Application |
|------------------------------------|--|
| Clock generator | Supplying the CPU clock and low-speed on-chip oscillator clock |
| EtherCAT slave controller | Handling EtherCAT communication |
| Ethernet MAC (ETHERC) | Handling EtherCAT communication |
| Interrupt controller (ICUA) | Handling EtherCAT Slave interrupts (EtherCAT, EtherCAT Sync0) and compare match interrupts (CMI0 and CMI1) |
| Compare match timer (CMT) | Handling the cycle counting of the compare match timer |
| Extended internal RAM | Shared memory area (Data RAM) and memory area for the program of the Cortex-M3 core (Instruction RAM) |
| Error control module (ECM) | Initializing the ERROROUT# pin |
| General-purpose input/output ports | Pins which control LED display and key entry |

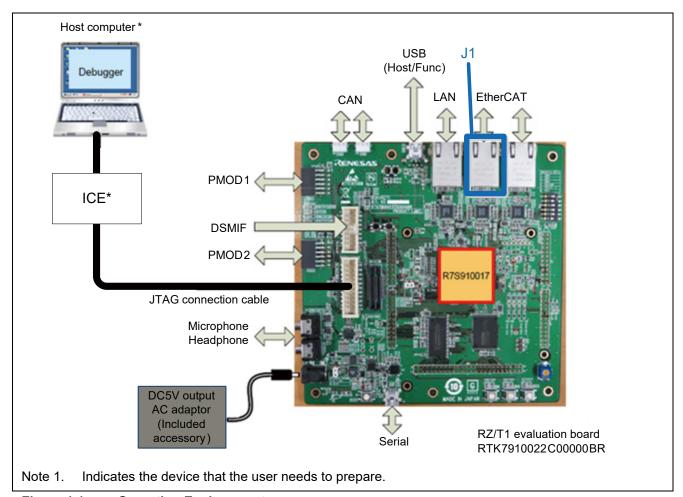


Figure 1.1 Operating Environment

For connection with the EtherCAT master, use the LAN interface J1 (EtherCAT1 port).

2. Operating Environment

The sample programs described in this application note assume the environment below.

Table 2.1 Operating Environment

| Item | Description |
|------------------------------------|---|
| Board | RZ/T1 evaluation board |
| | RTK7910022C00000BR |
| CPU | RZ/T1 (with a build-in R-IN engine) |
| | R7S910017 |
| Operating frequency | CPU clock (CPUCLK): 450 MHz (Cortex-R4) |
| | System clock (ICLK): 150 MHz (Cortex-M3) |
| Operating voltage | 3.3 V |
| Operating mode | 16-bit-bus boot mode |
| | SPI boot mode |
| Devices | NOR flash memory |
| | Macronix MX29GL512FLT2I-10Q |
| | Serial flash memory |
| | Macronix MX25L51245GMI-10G |
| | EEPROM |
| | Renesas R1EX24016ASAS0 |
| | Ethernet PHY |
| | Micrel KSZ8041TL |
| Communication protocol | EtherCAT® |
| Integrated development environment | IAR Systems Embedded Workbench® for ARM Version 8.20.2 |
| Emulator | IAR Systems I-jet |
| SSC Tool | Slave Stack Code (SSC) Tool Version 5.12 provided by EtherCAT |
| | technology Group (ETG) |
| Software PLC | Beckhoff Automation TwinCAT®3 |

3. Peripheral Modules

For the basics of the following items, refer to the RZ/T1 Group User's Manual: Hardware:

Clock generator, EtherCAT slave controller, Ethernet MAC (ETHERC), Interrupt controller (ICUA), Compare match timer (CMT), Error control module (ECM), extended internal RAM, and general-purpose I/O ports.

4. Hardware

4.1 Hardware Structure Example

Figure 4.1 shows an example of the hardware structure for the I/O controller sample program. Figure 4.2 shows an example of the hardware structure for the CiA402 sample program.

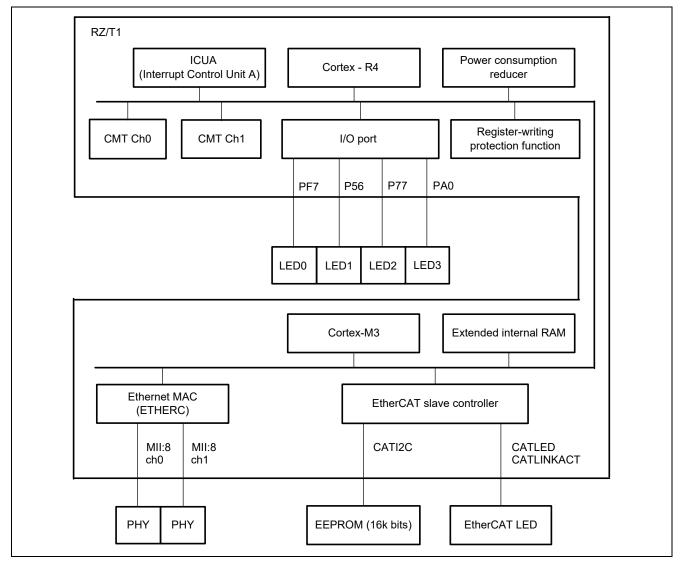


Figure 4.1 Hardware Structure Example for the I/O Controller Sample Program

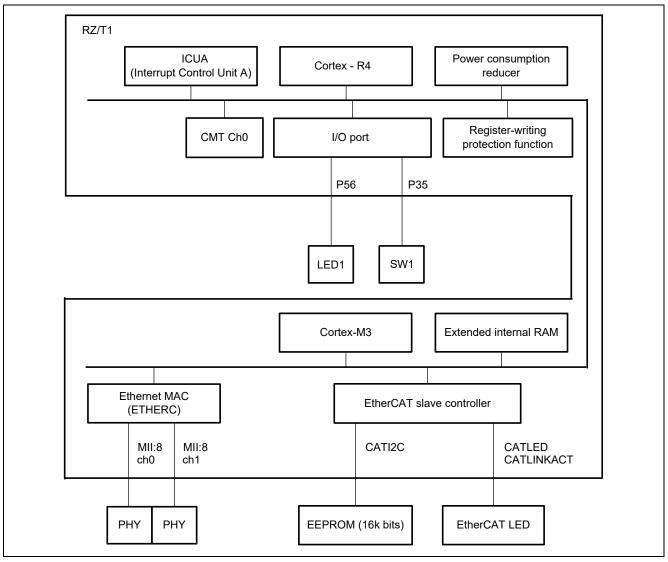


Figure 4.2 Hardware Structure Example for the CiA402 Sample Program

4.2 Pins Used

Table 4.1 shows pins and functions.

Table 4.1 Pins and Functions

| Item | Input/Output | Description |
|--------------|--------------|---|
| MD0 | Input | Select the operating mode |
| MD1 | Input | MD0 = L and MD1 = L and MD2 = L: SPI boot mode |
| MD2 | Input | MD0 = L and MD1 = H and MD2 = L: 16-bit bus boot mode |
| ETH_MDIO | Input/output | Management data signal input/output |
| ETH_MDC | Output | Management interface clock output |
| ETH0_RXC | Input/output | Receive clock I/O pins |
| ETH1_RXC | _ | |
| ETH0_RXER | Input | Reception data error signal input |
| ETH1_RXER | _ | |
| ETH0_RXDV | Input | Reception data enable signal input |
| ETH1_RXDV | _ | |
| ETH0_RXD0-3 | Input | Reception data signal input |
| ETH1_RXD0-3 | _ | |
| ETH0_TXC | Input | 10 M/100 M transmission clock (2.5 MHz/25 MHz) input |
| ETH1_TXC | _ | |
| ETH0_TXER | Output | Transmission error signal output |
| ETH1_TXER | _ | |
| ETH0_TXEN | Output | Transmission enable signal output |
| ETH1_TXEN | _ | |
| ETH0_TXD0-3 | Output | Transmission data signal output |
| ETH1_TXD0-3 | _ | |
| ETH0_COL | Input | Collision detection signal input |
| ETH1_COL | _ | |
| ETH0_CRS | Input | Carrier sense signal input |
| ETH1_CRS | _ | |
| CLKOUT25M0 | Output | External clock output for Ethernet PHY |
| CLKOUT25M1 | _ | |
| PHYRESETOUT# | Output | PHY RESETOUT output |
| PHYLINK0 | Input | PHY Link signal input for Ether Switch |
| PHYLINK1 | _ | |
| ETHSWSECOUT | Output | Per-second Ether Switch event output |
| ETH0_INT | Input | Ethernet PHY interrupt request signal input |
| ETH1_INT | _ | |
| CATI2CCLK | Output | EtherCAT EEPROM I2C clock signal output |
| CATI2CDATA | Input/output | EtherCAT EEPROM I2C data signal input/output |
| CATLINKACT1 | Output | EtherCAT Link/Activity LED signal output |
| CATLINKACT0 | | |
| CATLEDRUN | Output | EtherCAT RUN LED signal output |
| CATLEDSTER | Output | EtherCAT Dual-color state LED signal |
| CATLEDERR | Output | EtherCAT Error LED signal output |
| PF7 | Output | Switches LED0 on and off. |
| P56 | Output | Switches LED1 on and off. |

| Item | Input/Output | Description |
|------|--------------|---------------------------|
| P77 | Output | Switches LED2 on and off. |
| PA0 | Output | Switches LED3 on and off. |
| P35 | Input | SW1 input |

5. Software

5.1 Software Structure

Figure 5.1 shows the software structure for the sample programs.

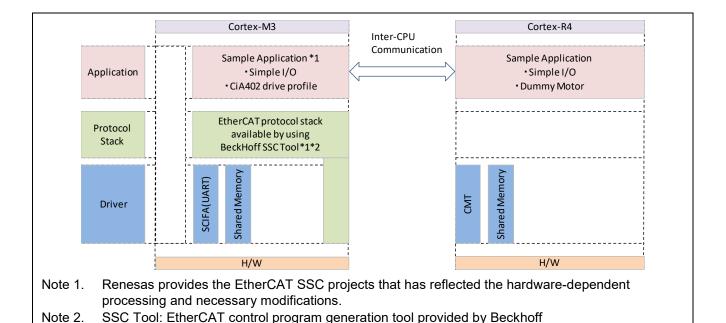


Figure 5.1 Software Structure Example

5.2 Directory Configuration

5.2.1 Directory Configuration of the Sample Programs for Cortex-M3

The \workspace\iccarm\Cortex-M3 directory is the current directory of the sample programs for Cortex-M3.

Table 5.1 Directory Structure of the Sample Programs for Cortex-M3

| Directory | Description |
|--|---|
| /CMSIS | Directory storing the definitions related to Cortex-M3 (CMSIS is used as is). |
| /Device/Renesas/RIN_Engine/Include | Directory storing include files |
| /Device/Renesas/RIN_Engine/Library | Directory storing libraries |
| /Device/Renesas/RIN_Engine/Source/Board | Directory storing board-dependent source files |
| /Device/Renesas/RIN_Engine/Source/Driver | Directory storing peripheral driver source files |
| /Device/Renesas/RIN_Engine/Source/Project_D ual/EtherCAT_SSC_DC-hwos | Directory storing the projects for the I/O controller sample programs |
| /Device/Renesas/RIN_Engine/Source/Project_D ual/EtherCAT_SSC_CiA402-hwos | Directory storing the projects for the CiA402 sample programs |
| /Device/Renesas/RIN_Engine/Source/Templates | Directory storing startup files |

5.2.2 Directory Configuration of the Sample Programs for Cortex-R4

The \workspace\iccarm\Cortex-R4 directory is the current directory of the sample programs for Cortex-R4.

Table 5.2 Directory Structure of the Sample Programs for Cortex-R4

| Directory | Description |
|-----------------------|---|
| / EtherCAT_SSC_DC | Directory storing the projects for the I/O controller sample programs |
| / EtherCAT_SSC_CiA402 | Directory storing the projects for the CiA402 sample programs |

5.3 Operation Overview

5.3.1 I/O Controller Sample Program

The program for the Cortex-R4 core makes initial settings after power is supplied to the core. First, the program copies the program code of the Cortex-M3 core, from the external flash memory to the extended internal RAM, to release the Cortex-M3 core from the reset state. Then, the program sets the LED-controlling port pins, initializes CMT0 and CMT1, and specifies the periodic event and interrupt settings.

During EtherCAT communication, the program for the Cortex-R4 core reads the output counter in the shared memory by using CMT0 periodic events, and then outputs the values of the low-order four bits to LED3 to LED0. The program also increments the input counter by using CMT1 periodic events, and copies the value to the shared memory.

The program for the Cortex-M3 core makes the initial setting for the board. It also makes the initial setting and other required settings for the EtherCAT protocol stack after the core is released from the reset state.

In the main loop, the program for the Cortex-M3 core executes the main process of the EtherCAT protocol stack.

The handler for EtherCAT interrupts and EtherCAT Sync0 interrupts copies the 32-bit output values from the EtherCAT master to the output counter in the shared memory. The handler also reads the value of the input counter in the shared memory, and sends the value to the EtherCAT master as 32-bit input.



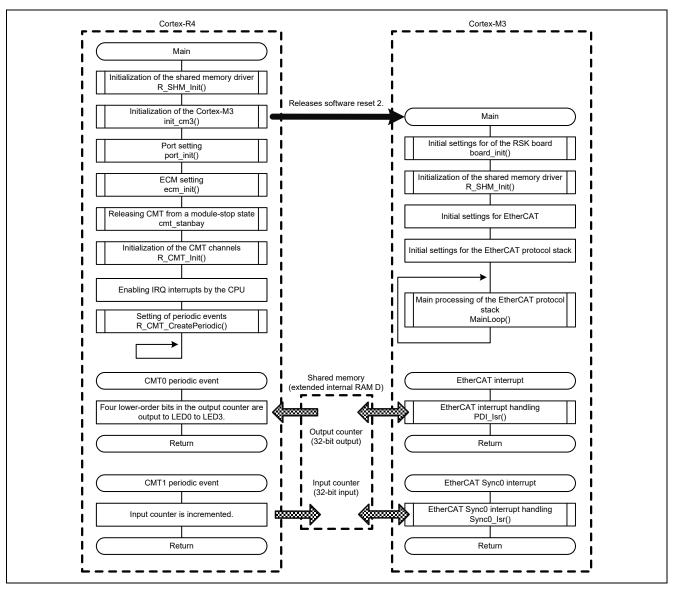


Figure 5.2 Simple Flowchart of the I/O Controller Sample Program

5.3.2 CiA402 Sample Program

Figure 5.3 shows a simple flowchart of the CiA402 sample program.

The program for the Cortex-R4 core makes initial settings after power is supplied to the core. First, the program copies the program code of the Cortex-M3 core, from the external flash memory to the extended internal RAM, to release the Cortex-M3 core from the reset state. Then, the program sets the LED-controlling port pins, initializes CMT0, and specifies the periodic event and interrupt settings.

In the main loop, the program checks whether an inter-CPU interrupt from the Cortex-M3 core has occurred. If an inter-CPU interrupt has occurred, the program accesses the shared memory to read the TargetPosition value and copy the ActualPosition value. The program also performs input for SW1 and output for LED1.

As pseudo motor control processing, CMT0 periodic events are used to increment the ActualPosition value until it becomes equal to the TargetPosition value while SW1 is being pressed.

The program for the Cortex-M3 core makes the initial setting for the board. It also makes the initial settings and other required settings for the EtherCAT protocol stack and the CiA402 drive profile after the core is released from the reset state.

In the main loop, the program for the Cortex-M3 core executes the main process of the EtherCAT protocol stack.

The handler for EtherCAT interrupts and EtherCAT Sync0 interrupts changes the status of CiA402, reads the ActualPosition value from the shared memory, and then writes the TargetPosition value. The handler also generates an inter-CPU interrupt for the Cortex-R4 core.



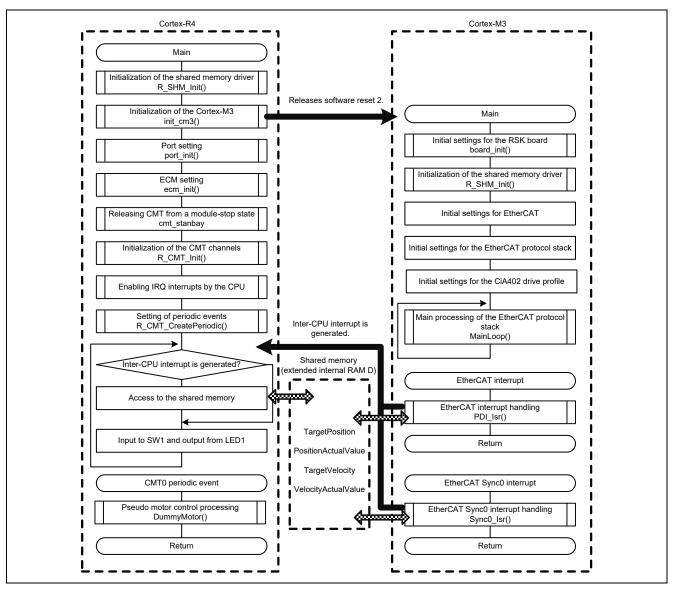


Figure 5.3 Simple Flowchart of the CiA402 Sample Program

6. Procedure for Generating Sample Programs

This section describes the procedure for generating sample programs. You need to prepare the EtherCAT Slave Stack Code Tool (SSC Tool) version 5.12 for this procedure.

6.1 I/O Controller Sample Program

- (1) Start the SSC tool from the Windows start menu. [EtherCAT Salve Stack Tool] > [SSC Tool]
- (2) Create a new project. [File] > [New]
- (3) Press [Import], then select the SSC Tool configuration file for the I/O controller sample program. \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_DC-hwos\RenesasSDK\CONFIG\Renesase RZT1 config.xml

The screenshot below shows that the configuration file has been imported.

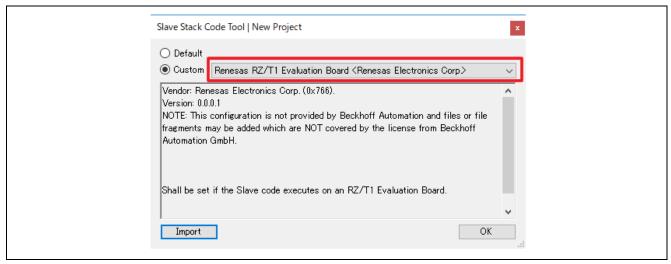


Figure 6.1 Importing SSC Tool Configuration File

Imported files are registered in the custom list and will be selectable from the drop-down list from the next time.

- (1) Click [OK]. Follow the dialog and import the hardware processing file (renesashw.c). \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_DC-hwos\RenesasSDK\renesashw.c
- (2) Select [Project] > [Create new Slave Files].
- (3) Press [Start] for generation of EtherCAT Salve Stack Code.
- (4) [New files created successfully] will appear on the screen for a successful generation. \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_DC-hwos\RenesasSDK\Src

6.2 CiA402 Sample Program

(1) Start the SSC Tool by double-clicking on the SSC project for the target sample program. \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_CiA402-hwos\RenesasSDK\ssc_project\RZT1-R EtherCAT demo CiA402.esp

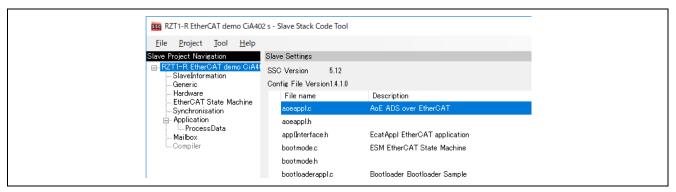


Figure 6.2 SSC Tool for the CiA402 Sample Program

- (2) Select [Project] > [Create new Slave Files].
- (3) Press [Start] for generation of the EtherCAT Slave Stack Code.
- (4) [New files created successfully] will appear on the screen for a successful generation. \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_CiA402-hwos\RenesasSDK\ssc_project\Src
- (5) Prepare the patch command if you don't have one yet.

Prepare You need GNU Patch 2.5.9 or later.

Download the patch command (version: 2.5.9) from the following web site, and then store the patch.exe file in a folder in a search path:

http://gnuwin32.sourceforge.net/packages/patch.htm

(6) Apply the patch.

Right-click on the apply patch.bat file and select [Run as administrator] > [OK].

The patch file includes the RZ/T1-related corrections for the SSC source files.

Batch file:

\workspace\iccarm\Cortex-M3\Device\Renesas\RIN Engine\Source\Project Dual

\EtherCAT SSC CiA402-hwos\RenesasSDK\apply patch.bat

Patch file:

\workspace\iccarm\Cortex-M3\Device\Renesas\RIN Engine\Source\Project Dual

\EtherCAT SSC CiA402-hwos\RenesasSDK\SSC CiA402 yyyymmdd.patch

Note; yyyymmdd is the date of creation of the patch file.

Figure 6.3 Example of Executing the Patch Command

After patching, the corrected source files are stored in the folder on the address shown below.

7. Setup Needed for Connection with TwinCAT

This section describes how to operate the sample programs by using TwinCAT3.

Before you can start the sample programs that you created, build their source codes.

7.1 Copying the ESI Files

Before starting TwinCAT, copy the ESI files that are included in the sample programs to TwinCAT. The copy destination is \TwinCAT\3.x\Config\IO\EtherCAT.

- For the I/O controller sample program \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_DC-hwos\RenesasSDK\ESI_File\RZT1-R_EtherCATdemo[DC].xml
- For the CiA402 sample program \workspace\iccarm\Cortex-M3\Device\Renesas\RIN_Engine\Source\Project_Dual\EtherCAT_SSC_CiA402-hwos\RenesasSDK\ESI_File\RZTI-R_EtherCAT_CiA402.xml

7.2 Connecting to TwinCAT

Start TwinCAT3 by using the procedure described below.

From the [Start] menu, select [Beckhoff] > [TwinCAT3] > [TwinCAT XAE (VS20XX)].

After the program is started, by selecting [File] > [New] > [Project], create a new project of the TwinCAT XAE Project type. The subsequent procedure is described below.

7.2.1 Setup for Reloading ESI Files

Load the ESI files of the sample program that you added from the TwinCAT.

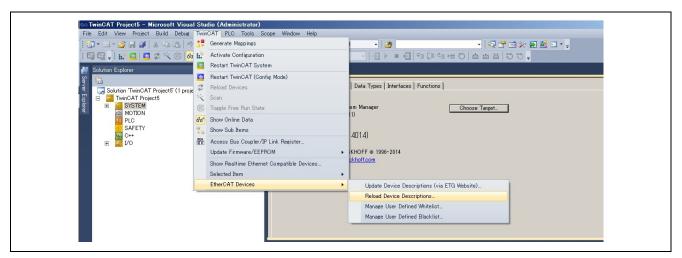


Figure 7.1 Reloading ESI Files

Select [Reload Device Descriptions] as in the above figure.

7.2.2 Scanning I/O Devices

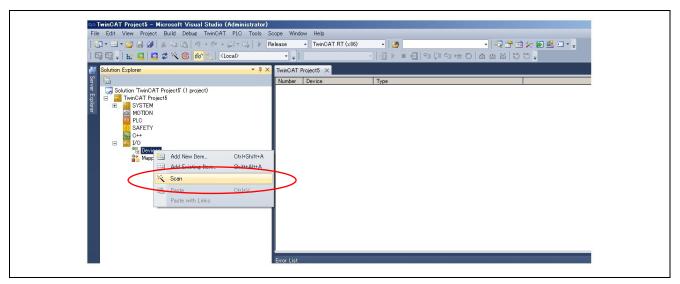


Figure 7.2 Scanning I/O Devices

As shown in the above figure, right-click [I/O Device] and select [Scan] from the menu to open a window. Execute scan in the window. After execution, perform operations as shown in Figure 7.3 and Figure 7.4.

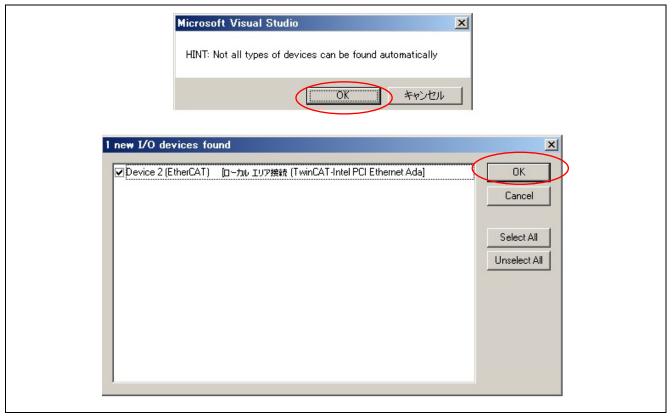


Figure 7.3 Settings for Scanning I/O Devices (1)

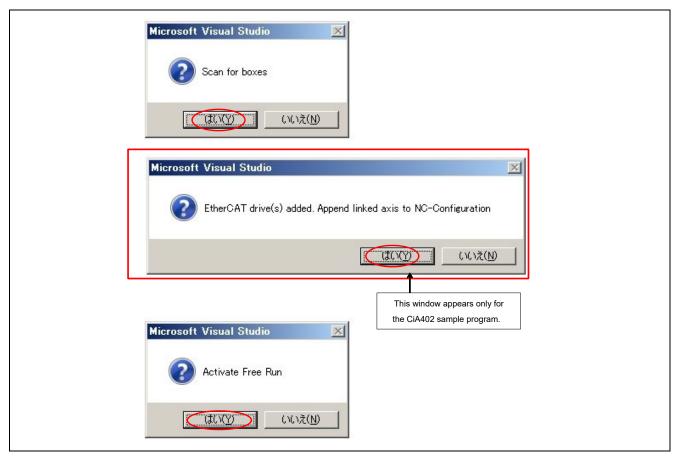


Figure 7.4 Settings for Scanning I/O Devices (2)

7.2.3 Updating EEPROM Data

If the data of another application has already been written to the EEPROM, replace the data.

The following shows the procedure for replacing the data on the EEPROM:

- (1) Double-click [Box 1] to display a panel on the right side of the window as in Figure 7.5
- (2) Select the [EtherCAT] tab.
- (3) Click the [Advanced Setting] button.
- (4) Select [ESC Access] > [EEPROM] > [Hex Editor].
- (5) Select [Download from list].
- (6) Select [Available EEPROM Description].
- For the I/O controller sample program

 Select [Renesas Electronics Corp.] > [RZ/T1-R Slaves] > [RZ/T1-R EtherCAT Demo[DC]]
- For the CiA402 sample program

 Select [Renesas Electronics Corp.] > [RZ/T1-R Slaves] > [RZ/T1-R EtherCAT CiA402]
- (7) Click the [OK] button.

 After the data is replaced, restart RZ/T1 (by turning it off and on, or resetting it) so that the new data is applied to
- (8) Execute [Restart TwinCAT System].

the microcomputer.

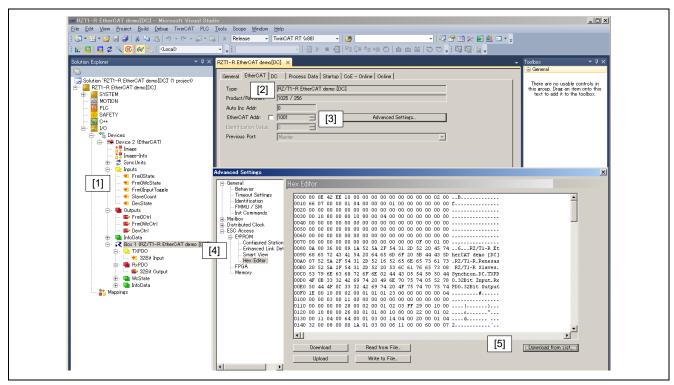


Figure 7.5 Procedure for Replacing the Data on the EEPROM (1)

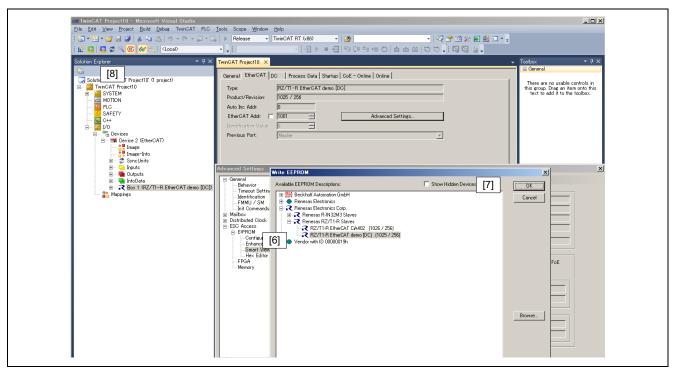


Figure 7.6 Procedure for Replacing the Data on the EEPROM (2)

7.2.4 Confirming the Communication Status

Select the [Online] tab, and then confirm that the status has been changed to OP.

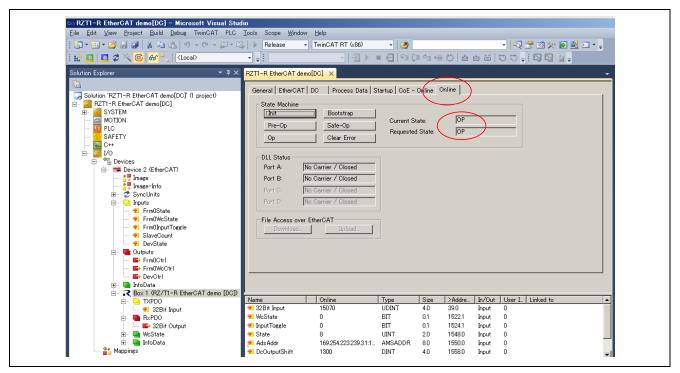


Figure 7.7 Confirming the Communication Status

Note: If the status has not been changed to OP, try [Activate Configuration], [Restart TwinCAT (Config Mode)], or another operation.

7.3 Sending/Receiving Data

7.3.1 For the I/O Controller Sample Program

(1) Checking 32-bit input

Select [32-Bit Input] > [Online]. You can confirm that the value is updated (incremented)

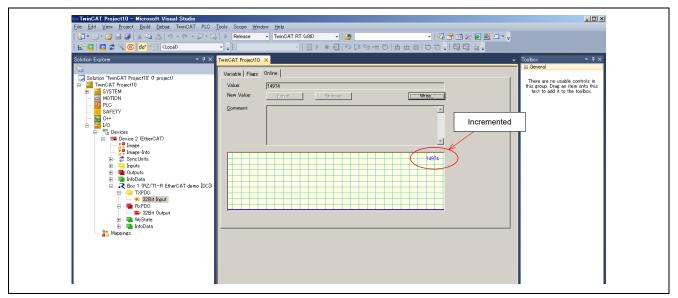


Figure 7.8 Checking 32-bit Input Values

(2) Checking 32-bit input

Select [32Bit Output] > [Online] > [Write].

Set a value for [Set Value Dialog], and then click the [OK] button.

Four lower order bits of the value are applied to LED3 to LED0. (LEDs are lit when the corresponding bits are 1.)

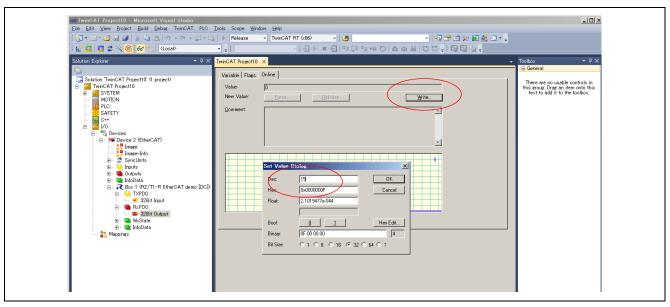


Figure 7.9 Checking 32-bit Input Values

7.3.2 For the CiA402 Sample Program

(1) Checking CiA402 status transition

Select [Control Word], set the value to 7, and then change the value to 15. Then, select [Status Word], and confirm that the value is 0x1237, which means, "Operation Enabled".

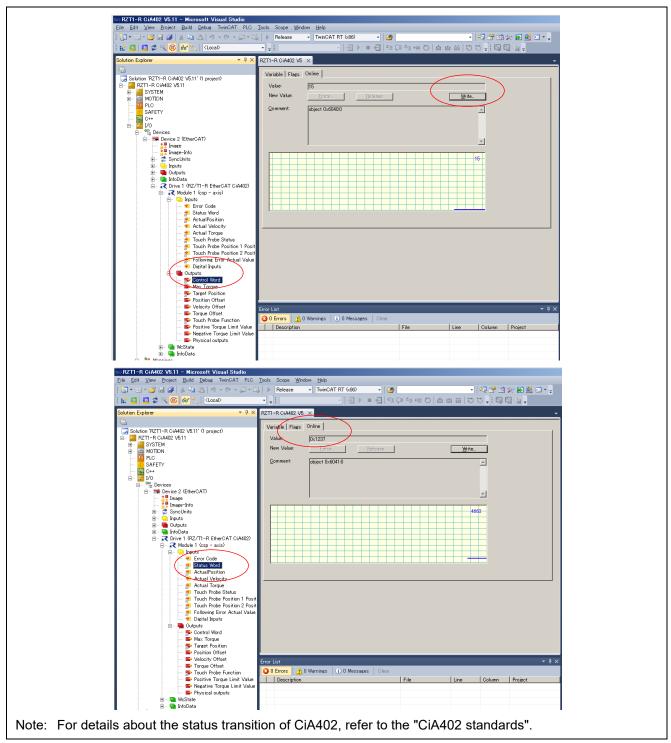


Figure 7.10 CiA402 Status Transition

(2) Pseudo motor operation

For [Target Position], set any value as the target value.

Then, press SW1 to change the value of [Actual Position]. While SW1 is being pressed, the value of [Actual Position] is incremented until reaching the value set for [Target Position]. When SW1 is turned off, the value of [Actual Position] is reset to 0.

Note that while SW1 is being pressed, LED1 is lit.

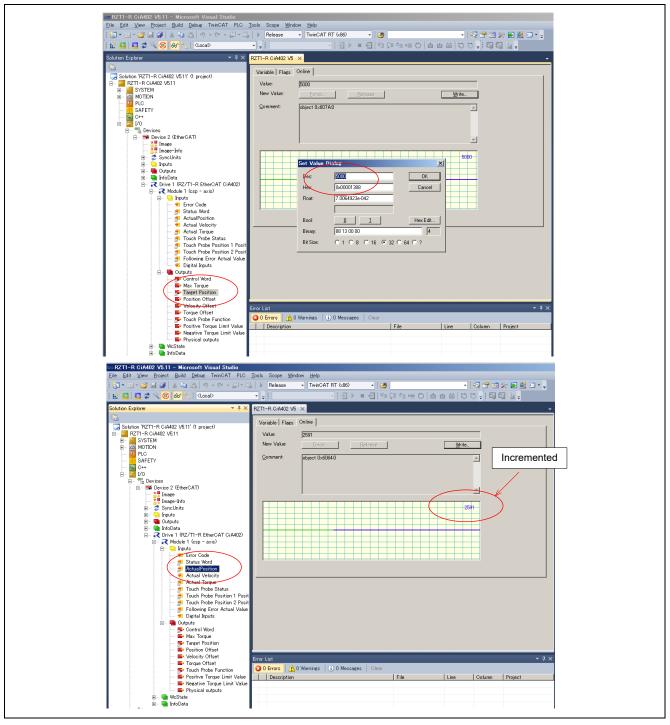


Figure 7.11 Pseudo Motor Operation

8. Sample Programs

Download the necessary sample programs from the Renesas Electronics website.

9. Reference Documents

• User's Manual: Hardware

RZ/T1 Group User's Manual: Hardware

(Download the latest version from the Renesas Electronics website.)

RZ/T1 Evaluation Board RTK7910022C00000BR User's Manual (Download the latest version from the Renesas Electronics website.)

Documents/Application Notes/Sample Codes

RZ/T1 Group Application Note: Initial Settings

(Download the latest version from the Renesas Electronics website.)

RZ/T1 Group Application Note: Compare Match Timer (CMT) (Download the latest version from the Renesas Electronics website.)

RZ/T1 Group Application Note: Procedure of EtherCAT Communication for Devices with a Built-in R-IN Engine (Download the latest version from the Renesas Electronics website.)

 Technical Update/Technical News (Download the latest version from the Renesas Electronics website.)

• User's Manual: Development Environment

For documents of IAR Integrated Development Environment (Embedded Workbench® for ARM), download the latest version from the IAR Systems website.

(Download the latest version from the IAR Systems website.)

Website and Support

Renesas Electronics Website http://www.renesas.com/

Inquiries

http://www.renesas.com/contact/

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| Devision History | Application Note: EtherCAT Sample Program Implementation Guide for |
|------------------|--|
| Revision History | Devices with a Built-in R-IN Engine Not Utilizing the HW-RTOS |

| Rev. | Date | Description | |
|------|---------------|-------------|--|
| Rev. | | Page | Summary |
| 1.00 | Jul. 15, 2016 | _ | First Edition issued |
| 1.10 | Aug. 31, 2018 | 15 | 6. Procedure for Generation Sample Programs, modified. |

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.4.0-1 November 2017)



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